

US00D467914S

(12) **United States Design Patent**
Hwang

(10) **Patent No.:** **US D467,914 S**

(45) **Date of Patent:** **** Dec. 31, 2002**

(54) **STACKED GBIC GUIDE RAIL ASSEMBLY**

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(**) **Term:** **14 Years**

(21) **Appl. No.:** **29/143,967**

(22) **Filed:** **Jun. 21, 2001**

(51) **LOC (7) Cl.** **14-99**

(52) **U.S. Cl.** **D14/299**

(58) **Field of Search** **D14/299, 137,
D14/239; D13/147, 158, 184; 439/607,
608, 609, 610; 335/132, 202; 361/728,
732, 740**

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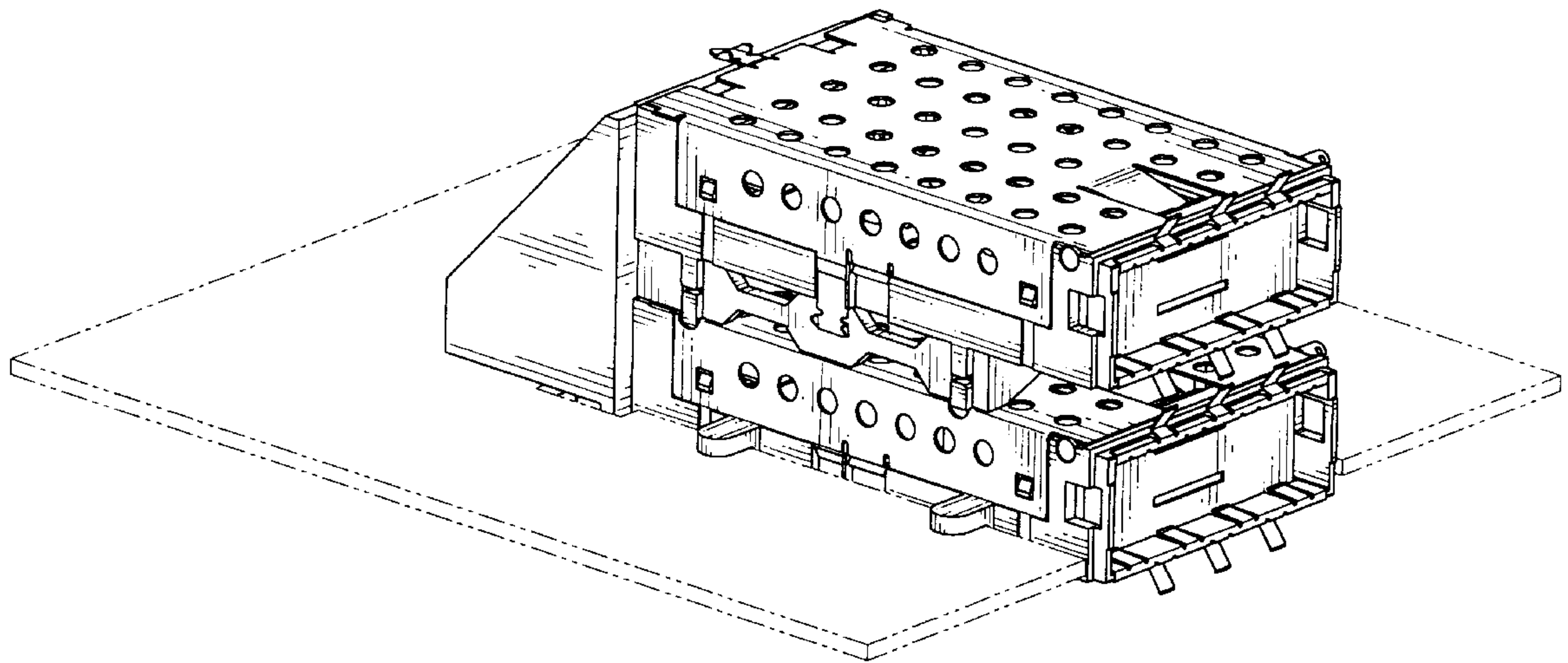
(57) **CLAIM**

The ornamental design for a stacked GBIC guide rail assembly, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a stacked GBIC guide rail assembly showing my new design; FIG. 2 is a front view thereof; FIG. 3 is a rear view thereof; FIG. 4 is a left side elevational view thereof; FIG. 5 is a right side elevational view thereof; FIG. 6 is a top plan view thereof; FIG. 7 is a bottom plan view thereof; and, FIG. 8 is a perspective view thereof mounted to a circuit board which is shown in broken lines for illustrative purposes only and forms no part of the claimed design.

1 Claim, 7 Drawing Sheets



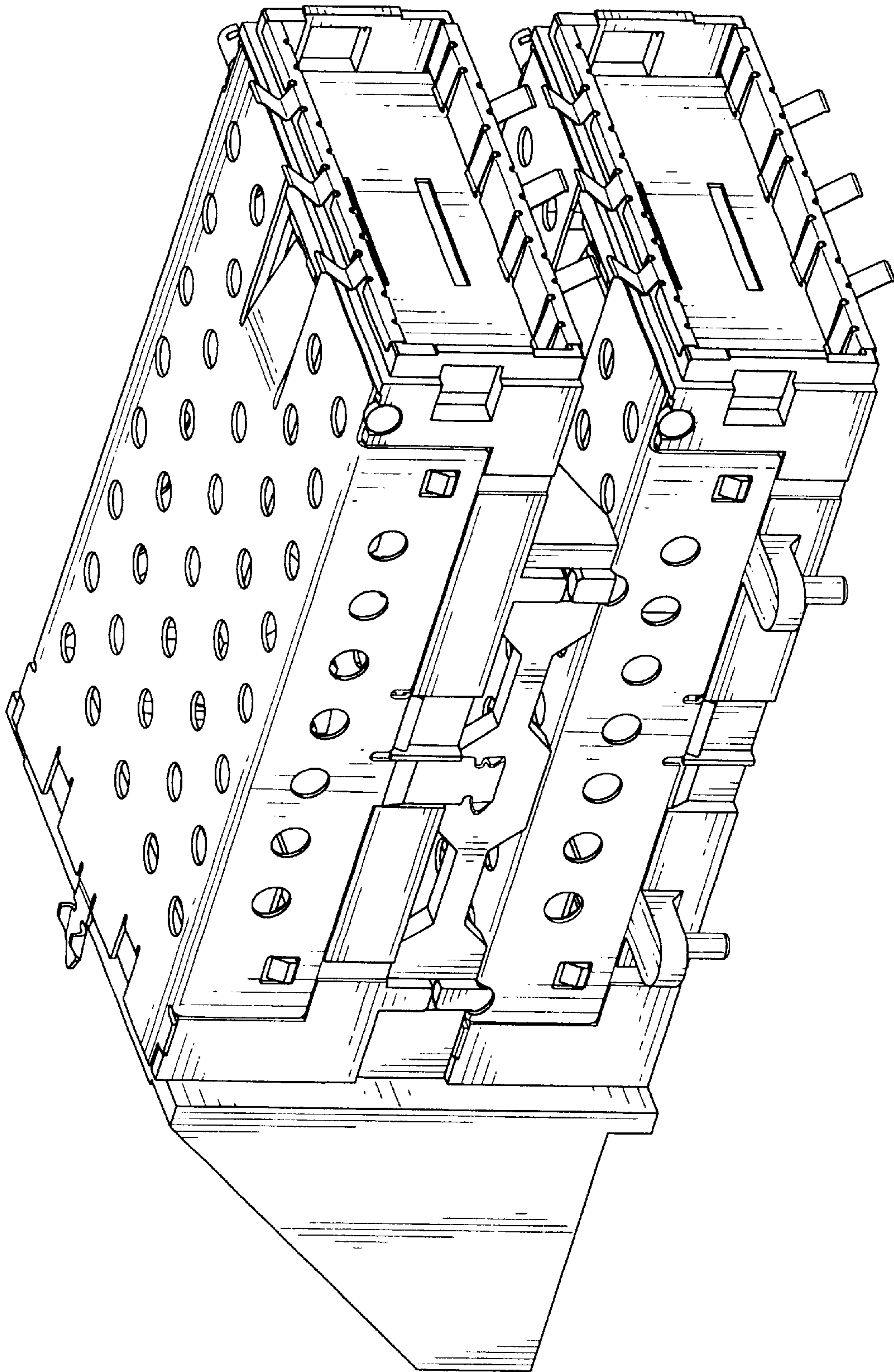


FIG. 1

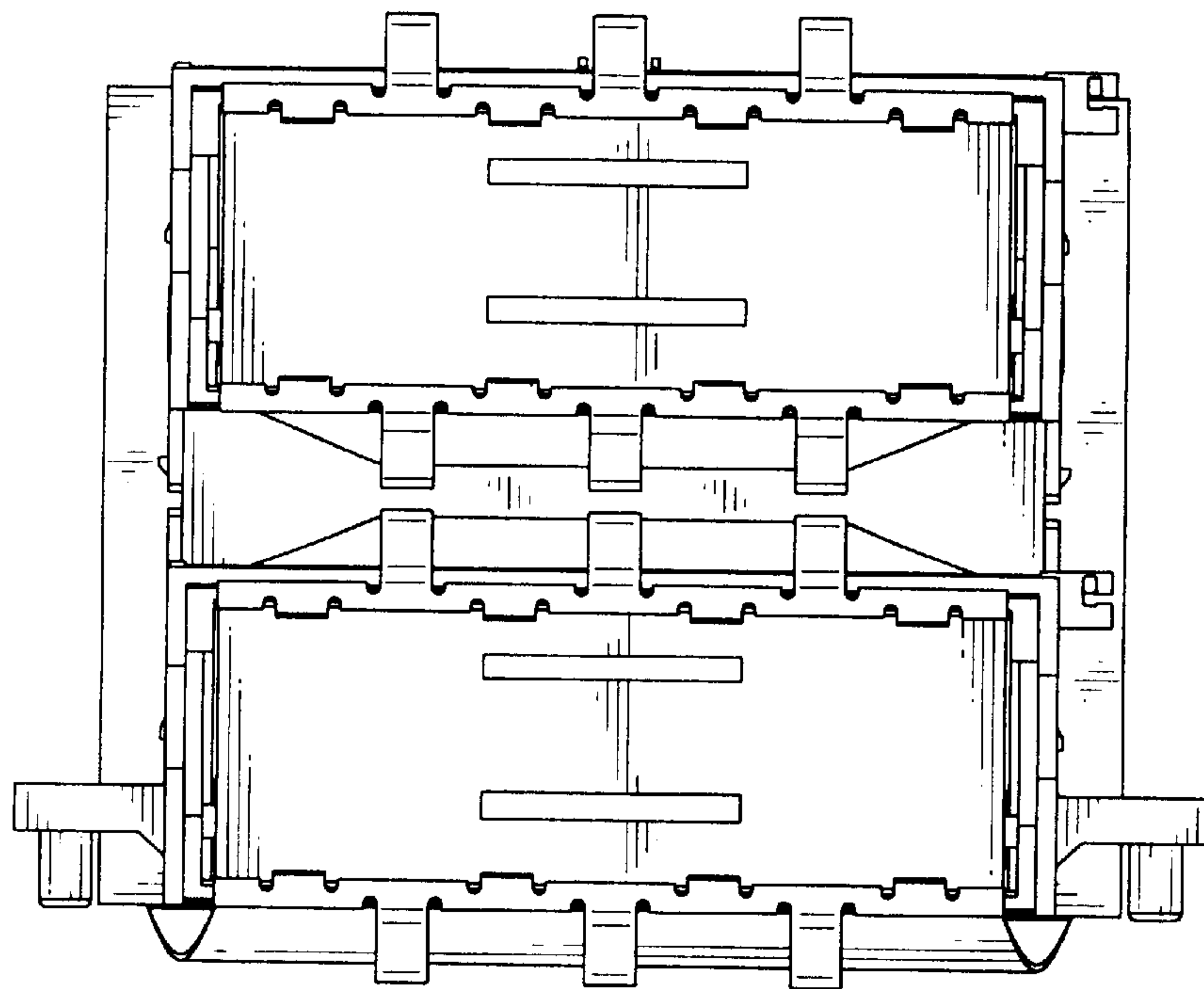


FIG. 2

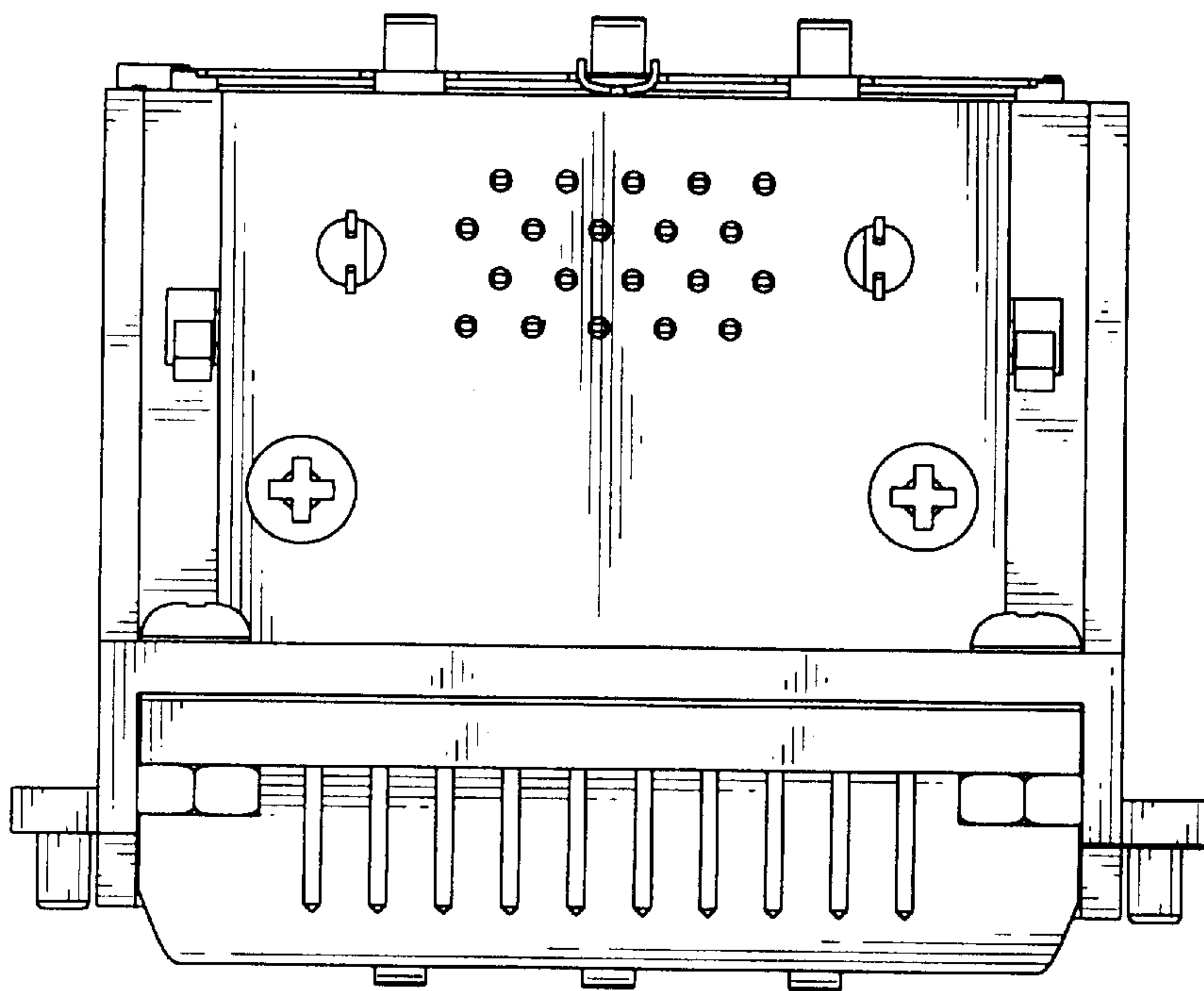


FIG. 3

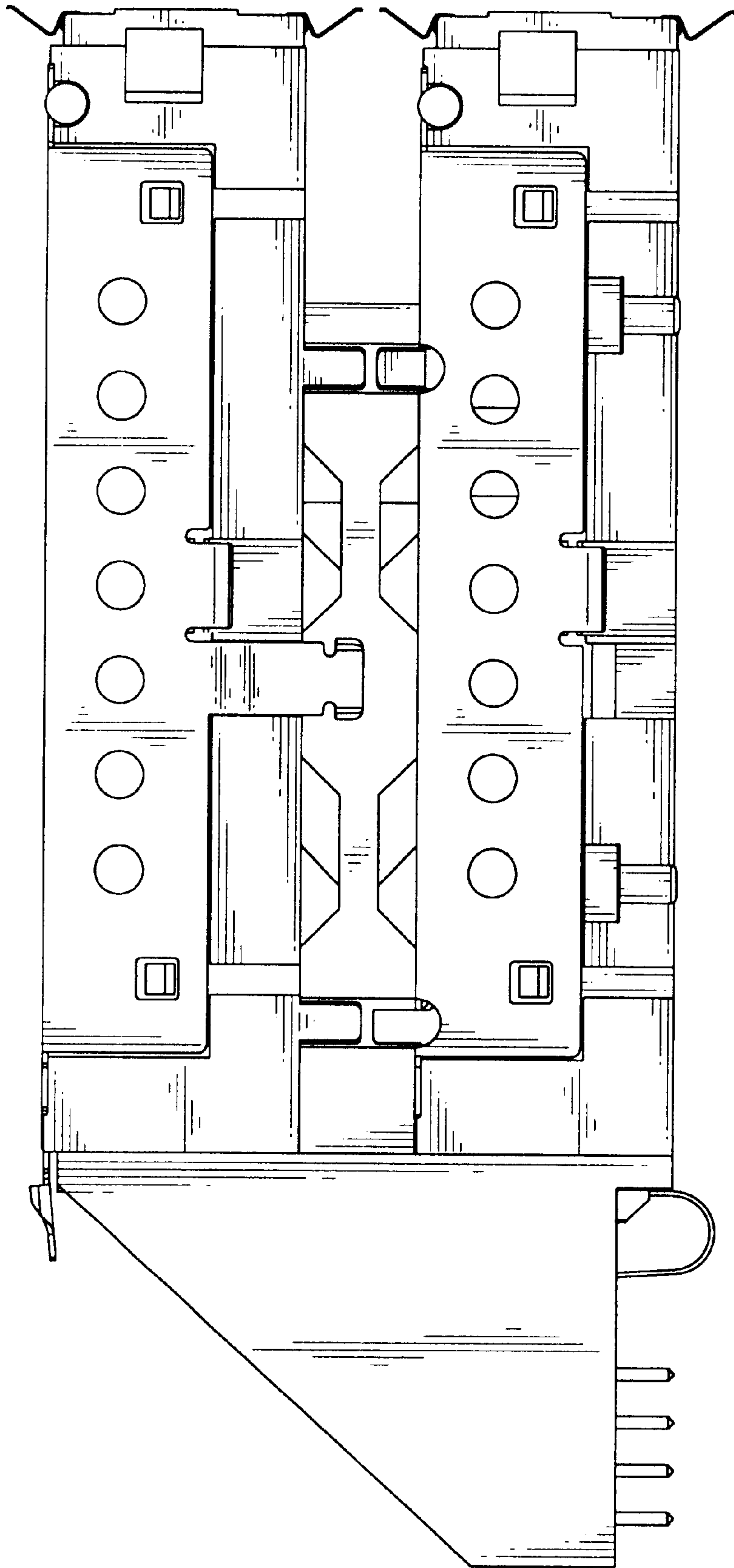


FIG. 4

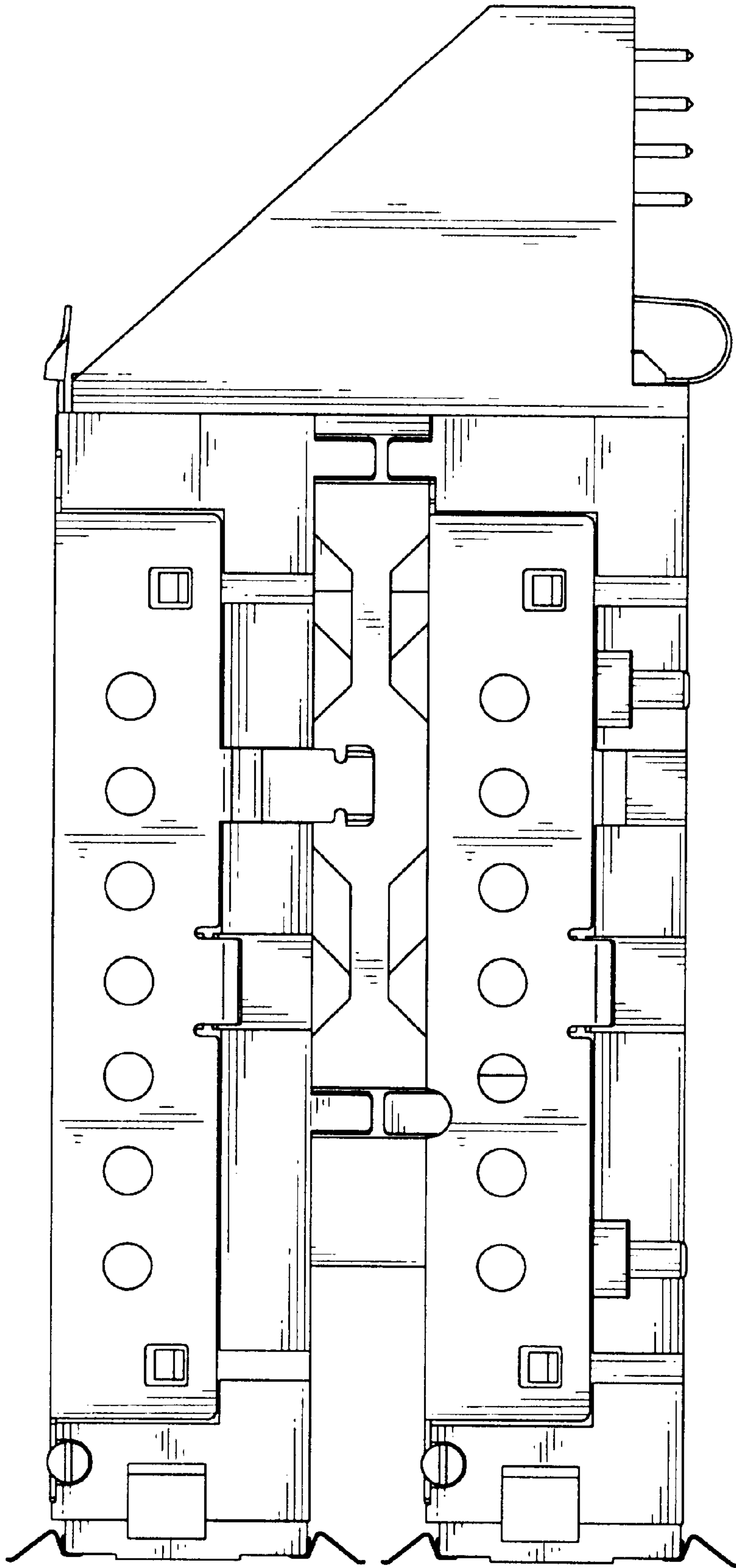


FIG. 5

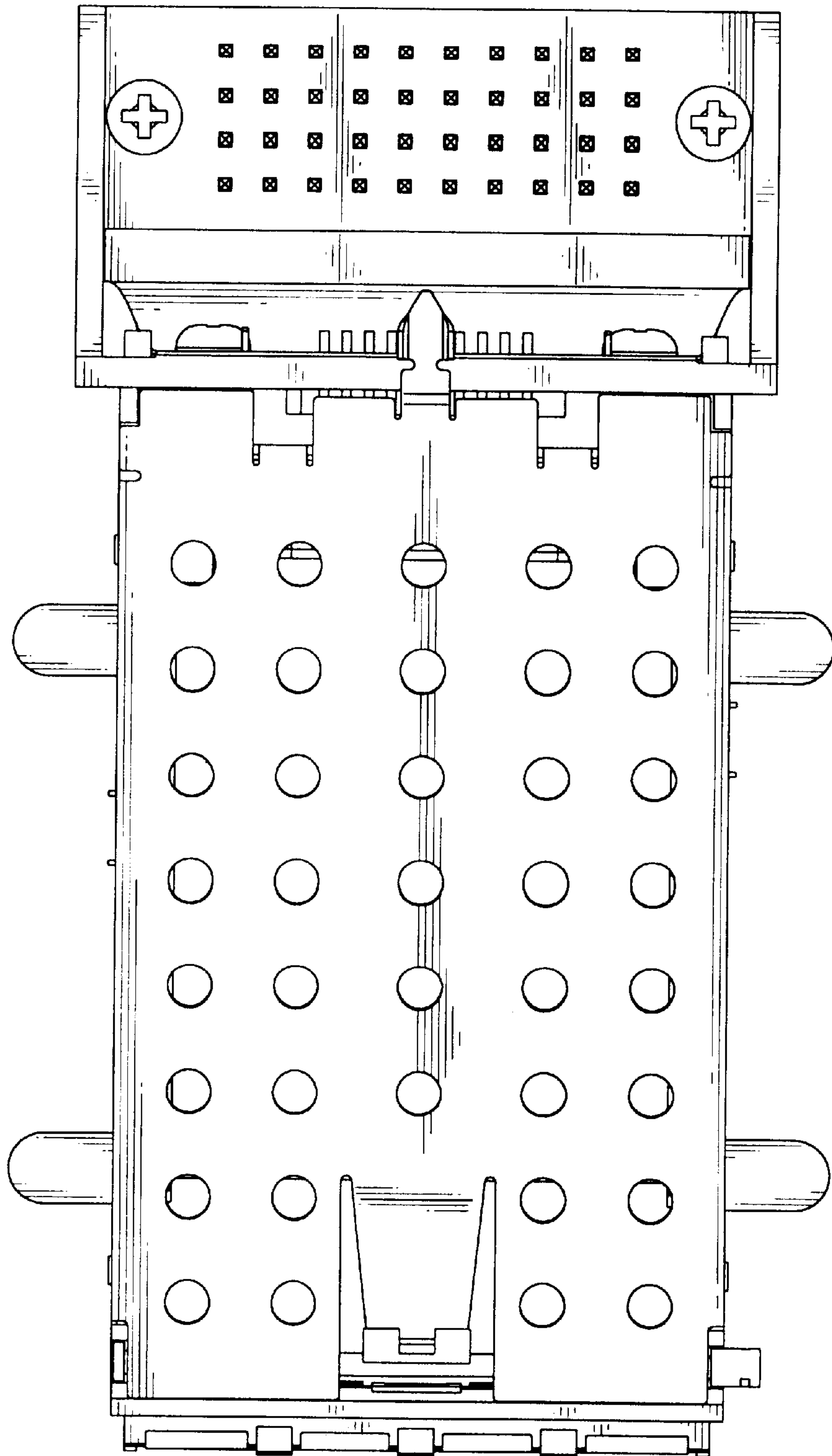


FIG. 6

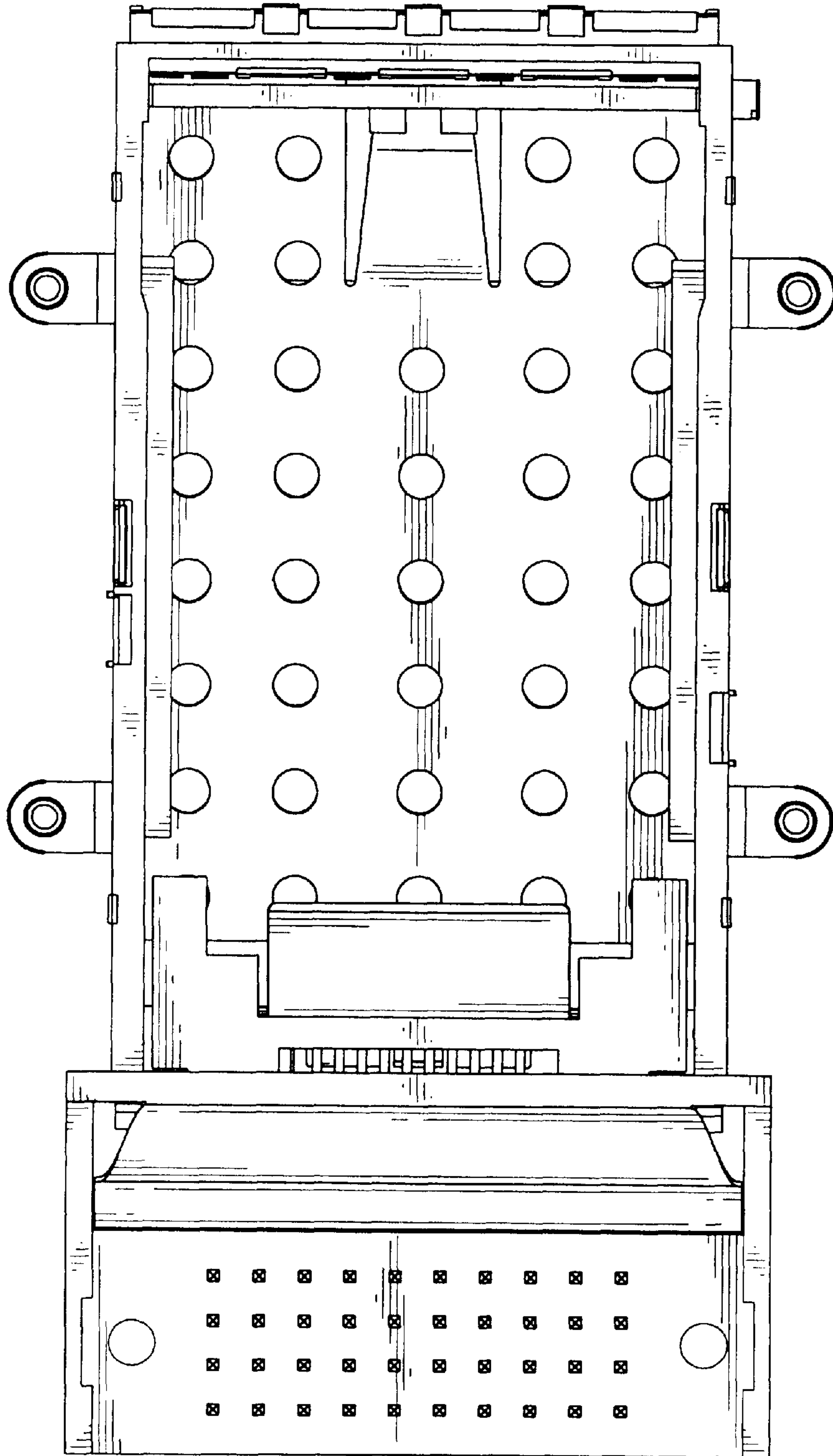


FIG. 7

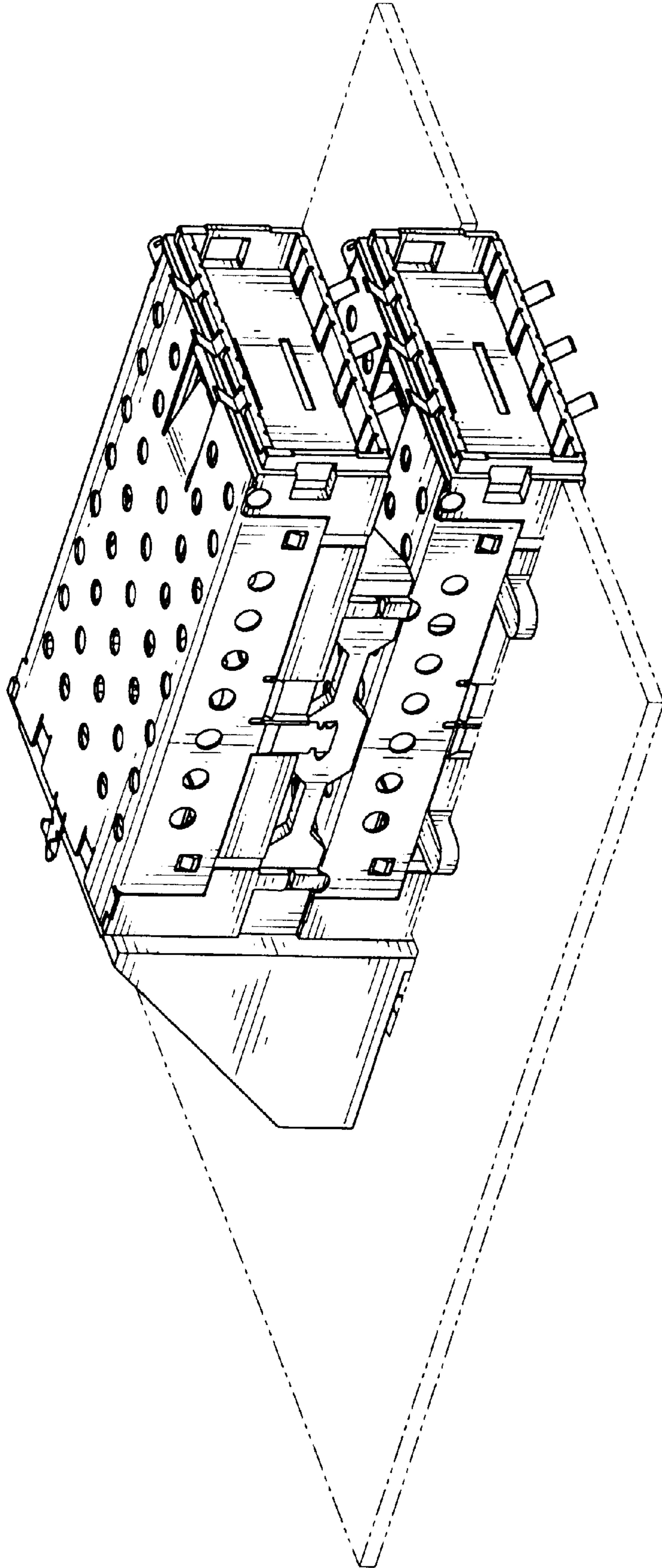


FIG. 8